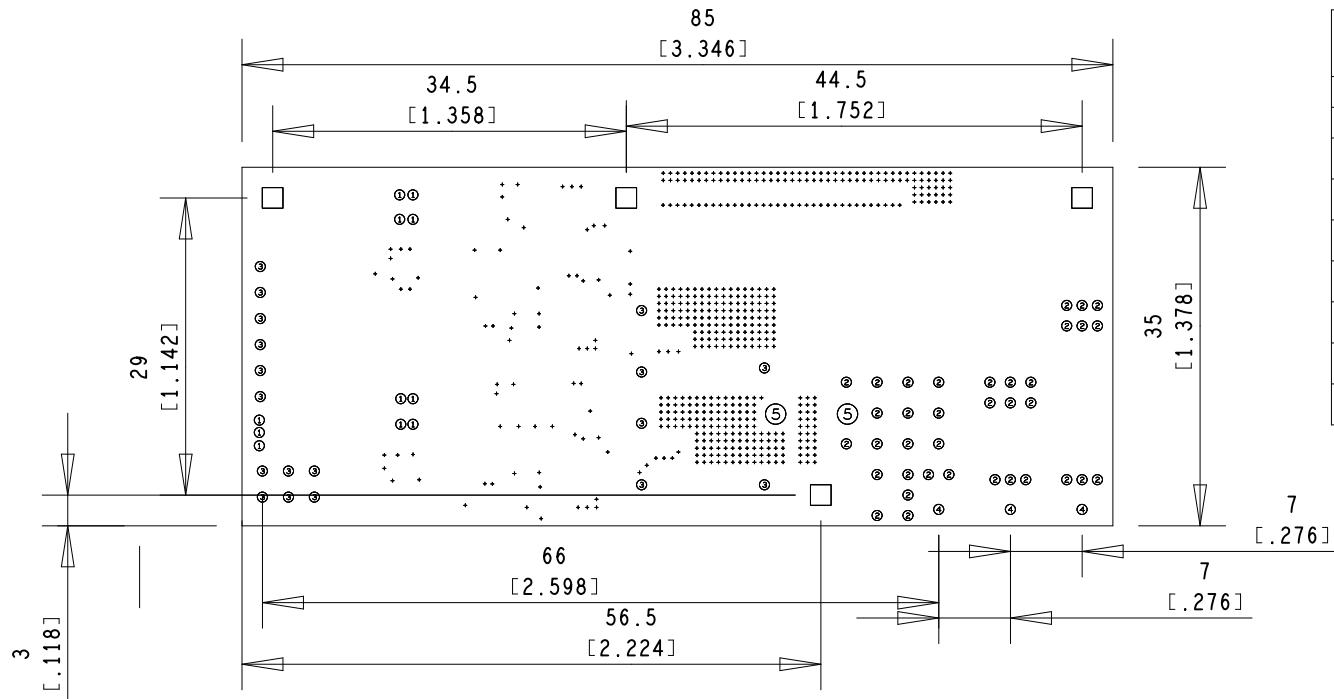
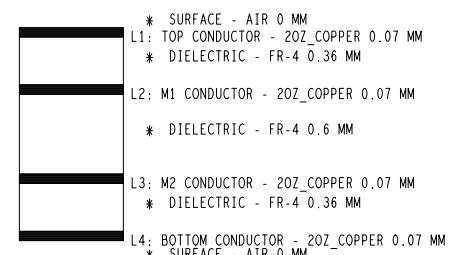


NOTES - UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. THIS BOARD SHALL MEET THE REQUIREMENT OF IPC-A-6012 CLASS 2.
3. LAMINATE TO BE HIGH Tg FR4 OR EQUIVALENT.
4. BOARD SHALL MEET THE REQUIREMENT OF UL 796 AND 94V-0 FLAMMABILITY RATING
5. VENDORS UL LOGO OR DESIGNATION SHALL BE LOCATED ON SECONDARY SIDE OF BOARD, RUBBER STAMPED OR SILKSCREENED.
6. SURFACE FINISH IS ENIG, 3-8  $\mu$ INCHES of Au OVER MINIMUM 100 $\mu$ INCHES Ni
7. ALL HOLE DIAMETERS ARE STATED AS FINISHED HOLE SIZES. ALL PLATED THROUGH HOLES TO HAVE A MINIMUM OF 0.025mm CU.
8. SOLDERMASK SHALL BE PHOTO-IMAGED LIQUID POLYMER, IN ACCORDANCE WITH IPC-SM-810, TYPE B, CLASS T, OVER BARE COPPER. SOLDERMASK COLOR: GREEN
9. SILKSCREEN SHALL BE NON-CONDUCTIVE WHITE EPOXY INK AND TO BE REMOVED FROM SOLDER PADS PROVIDING A MINIMUM CLEARANCE OF 0.0762mm
10. THIS BOARD TO BE RoHS COMPLIANT.
11. PANELING: NOT REQUIRED, ALLOWABLE AT MANUFACTURER'S DISCRETION



DRILL CHART: TOP to BOTTOM			
ALL UNITS ARE IN MILLIMETERS			
FIGURE	SIZE	PLATED	QTY
+	0.305	PLATED	523
①	0.432	PLATED	11
②	0.711	PLATED	36
③	1.0	PLATED	18
④	1.65	PLATED	3
⑤	2.0	PLATED	2
□	4.0	NON-PLATED	4



DESIGN CROSS SECTION CHART  
TOTAL THICKNESS 1.6 MM

BOARD DETAILS

Minimum Trace Width (Gap): 0.254 mm  
 Minimum Feature Size (Width): 0.254 mm  
 Minimum Hole Size: 0.3 mm  
 Copper weight: 2oz all layers  
 Total number of drills: 597

GaN Systems	Product GS66508B HALF BRIDGE DAUGHTER BOARD	Sheet Description		Rev B
		FABRICATION DRAWING		
Date	25-JUN-2016	Drawing	Sheet	
		GS66508B-EVBDB-SCH	1 of 1	